



Material Content Data Sheet



Halogen-Free

Sales Product Name	BTN8962TA	Issued	25. June 2021
MA#	MA005565002		
Package	PG-TO263-7-1	Weight*	1533.19 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip_1	inorganic material	silicon	7440-21-3	3.697	0.24	0.24	2411	2411
chip_2	inorganic material	silicon	7440-21-3	1.162	0.08	0.08	758	758
chip_3	inorganic material	silicon	7440-21-3	1.212	0.08	0.08	791	791
leadframe	inorganic material	phosphorus	7723-14-0	0.243	0.02		158	
	non noble metal	iron	7439-89-6	0.810	0.05		528	
	non noble metal	copper	7440-50-8	808.613	52.75	52.82	527403	528089
wire	non noble metal	aluminium	7429-90-5	6.380	0.42	0.42	4161	4161
encapsulation	inorganic material	zinc oxide	1314-13-2	5.881	0.38		3836	
	miscellaneous	miscellaneous	-	23.523	1.53		15343	
	plastics	epoxy resin	-	88.213	5.75		57535	
	inorganic material	silicon dioxide	60676-86-0	470.467	30.69	38.35	306854	383568
lead finish	non noble metal	tin	7440-31-5	13.037	0.85	0.85	8503	8503
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.212	0.01	0.01	139	140
solder	non noble metal	tin	7440-31-5	0.061			40	
	noble metal	silver	7440-22-4	0.076			50	
	non noble metal	lead	7439-92-1	2.921	0.19	0.19	1905	1995
glue	plastics	Polyimide	26023-21-2	0.338	0.02	0.02	220	220
heatspreader	inorganic material	phosphorus	7723-14-0	0.032			21	
	non noble metal	iron	7439-89-6	0.106	0.01		69	
	non noble metal	copper	7440-50-8	106.210	6.93	6.94	69274	69364
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

- Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
- Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
- All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com